

COLOR LASER DISPLAY APPARATUS HAVING FLUORESCENT
SCREEN SCANNED WITH MODULATED ULTRAVIOLET LASER
LIGHT

BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to a color laser display apparatus having a fluorescent screen scanned with laser light.

Description of the Related Art

High-power laser light sources having output power in the order of watts are needed for increasing luminosity of color laser display apparatuses. Conventionally, high-power Ar⁺ gas lasers or Kr⁺ gas lasers have been used as the laser light sources in the color laser display apparatuses. However, the laser light sources using gas lasers have low energy conversion efficiency, which is typically 0.1%, and require a water cooling system. In addition, the size and cost of the laser light sources using the gas lasers are great.

As reported in Laser Focus World (December 1997) p.52, recently, laser-diode-excited SHG solid-state lasers have been used as a short-wavelength visible laser light source. For example, SHG solid-state lasers which emit laser light of a green wavelength of 532 nm have higher energy conversion efficiency than those of the gas lasers, where YAG lasers which emit laser light having a wavelength of 1,064 nm are used in the SHG solid-state lasers.

However, in the above SHG solid-state lasers, the excitation laser light is visible to human eyes. Therefore, color purity of the display is affected by the excitation laser light.

In addition, in the laser-diode-excited SHG solid-state lasers, a kind of noise, called

longitudinal mode competition, occurs when the output power is increased. For example, Laser Focus World (May 1998) p.243 reports that red solid-state lasers generate as much as 50% noise while noise generated in blue or green solid-state lasers generate is less than 3%. In order to control the longitudinal mode, an etalon may be used as a wavelength selection element. However, if single-mode oscillation is realized by using an etalon, large energy loss occurs. Therefore, it is impossible to obtain high power output and high luminosity.

As described above, when the above laser-diode-excited SHG solid-state lasers are used as a laser light source in the color laser display apparatuses, the improvement is made in the size and the energy conversion efficiency. However, there are still problems of performance and cost.

SUMMARY OF THE INVENTION

The first object of the present invention is to provide a color laser display apparatus in which color purity of the display is not affected by the excitation laser light.

The second object of the present invention is to provide a downsized, low noise, highly efficient color laser display apparatus.

According to the present invention, there is provided a color laser display apparatus which contains a laser light source which emits ultraviolet laser light, a modulation unit which modulates the ultraviolet laser light, a display unit which includes a fluorescent screen, and a scanning unit which two-dimensionally scans the fluorescent screen with the ultraviolet laser light. The fluorescent screen includes, for each pixel, red fluorescent material which emits red light in

response to the ultraviolet laser light, green
fluorescent material which emits green light in
response to the ultraviolet laser light, and blue
fluorescent material which emits blue light in
5 response to the ultraviolet laser light.

That is, in the color laser display apparatus
according to the present invention, a color image is
displayed by scanning the fluorescent screen with
the ultraviolet laser light generated by the
10 ultraviolet laser light source, and the three
primary colors can be generated with only one
ultraviolet laser light beam by the red, green, and
fluorescent materials arranged at positions of each
pixel on the fluorescent screen. Therefore,
15 reliability is increased, and cost can be decreased.

In addition, since the excitation laser light
is ultraviolet laser light, the human eyes are
substantially insensible to the excitation laser
light. Therefore, color purity of the display is not
20 affected by the excitation laser light.

The color laser display apparatus according to
the present invention may have the following
additional features.

(1) The laser light source may be a
25 semiconductor laser device. In this case, the water
cooling system, which is required when the gas laser
is used as the laser light source, is unnecessary,
and therefore the size of the color laser display
apparatus can be reduced. In addition, a modulated
30 light can be obtained by direct modulation in the
semiconductor laser device.

(2) The above semiconductor laser device may
have an active layer made of a GaN material, where
the GaN material may be any semiconductor material
35 which contains both gallium and nitrogen as at least
a portion of their constituent elements. The GaN

material may be, for example, GaN, $\text{In}_x\text{Ga}_{1-x}\text{N}$, $\text{GaN}_y\text{As}_{1-y}$, $\text{In}_x\text{Ga}_{1-x}\text{N}_y\text{As}_{1-y}$, or $\text{Al}_x\text{Ga}_{1-x}\text{N}$, where $0 < x < 1$, and $0 < y < 1$. When the laser light source is realized by a semiconductor laser device which has an active layer made of a GaN material, a wavelength conversion element is unnecessary, and therefore the noise due to the longitudinal mode competition is not generated. Thus, the amount of noise can be reduced to less than 1%.

(3) The above semiconductor laser device having an active layer made of a GaN material may be one of a tapered-amplifier type, an α -DFB (Distributed Feedback) type, a phase-synchronization array type, and a surface emitting type. In this case, a sufficient amount of fluorescent light can be generated, and therefore an image can be displayed with high luminosity.

(4) The laser light source may be a laser device including a semiconductor laser device which has an active layer made of a GaN material so as to emit excitation laser light, and a surface emitting semiconductor laser device which has an active layer made of a GaN material and formed on a substrate. The surface emitting semiconductor laser device is excited by the excitation laser light to emit the ultraviolet laser light. In this case, the laser light source can emit ultraviolet laser light having high intensity, and therefore an image of high luminosity can be displayed. Preferably, the wavelength of the ultraviolet laser light is in the range from 380 nm to 420 nm.

(5) The laser light source may be a fiber laser device including an excitation light source, an optical fiber, and a wavelength conversion element. The excitation light source emits excitation light. The optical fiber is doped with at

least one rare earth element which emits a laser beam when excited by the excitation light, and the at least one rare earth element includes Pr^{3+} . The wavelength conversion element converts the laser beam into the ultraviolet laser light. In this case, high output power can be obtained by the laser light source, and therefore the color laser display apparatus can display a color image with high luminosity.

The above fiber laser device may be a double-cladding fiber laser device which emits ultraviolet laser light having a wavelength of 360 nm. In this case, output power in the order of 10 watts can be achieved in the laser light source.

(6) The red fluorescent material may be ZnCdS:Ag , the green fluorescent material may be ZnS:Cu , and the blue fluorescent material may be ZnS:Ag .

DESCRIPTION OF THE DRAWINGS

Fig. 1 is a diagram illustrating the construction of the color laser display apparatus as the first embodiment of the present invention.

Fig. 2 is a diagram illustrating the construction of the color laser display apparatus as the second embodiment of the present invention.

Fig. 3 is a diagram illustrating the construction of the color laser display apparatus as the third embodiment of the present invention.

Fig. 4 is a diagram illustrating the construction of the color laser display apparatus according to the fourth embodiment of the present invention.

Fig. 5 is a plan view illustrating the laser light source of the exposure apparatus associated with the fourth embodiment of the present invention.

Fig. 6 is a plan view illustrating the

terminal surfaces of the multimode fibers which have been arranged in an array form according to the fourth embodiment of the present invention.

Fig. 7 is a graph illustrating the transmittance characteristics of the narrow bandwidth band pass filters of the laser light source illustrated in Fig. 5.

Fig. 8 is a perspective view illustrating the construction of the grating light valve element (GLV element) employed as the optical modulating array element.

Fig. 9A and Fig. 9B are diagrams illustrating the operational principles of the GLV element.

Fig. 10 is a perspective view illustrating the semiconductor laser chip which is the light source of the exposure apparatus associated with the fifth embodiment of the present invention.

Fig. 11A is a plan view illustrating the semiconductor laser chip as the light source, and Fig. 11B is a sectional view taken along the optical axis of Fig. 11A.

Fig. 12 is a perspective view illustrating the light source employed in the fifth embodiment of the present invention.

Fig. 13A and Fig. 13B are perspective views illustrating alternate light sources employed in the fifth embodiment of the present invention.

Fig. 14 is a sectional view illustrating an example of the layering structure of a GaN semiconductor laser that has a broad area emittance range employable as the laser light source of the exposure apparatus of the present invention.

Fig. 15 is a sectional view illustrating the construction of a semiconductor laser excited solid state laser employable as the laser light source of the exposure apparatus of the present invention.

Fig. 16 is a sectional view illustrating the construction of an FHG (Fourth Harmonic Generation) fiber laser employable as the laser light source of the exposure apparatus of the present invention.

Fig. 17 is a sectional view illustrating the construction of an SHG (Second Harmonic Generation) fiber laser employable as the laser light source of the exposure apparatus of the present invention.

DESCRIPTION OF PREFERRED EMBODIMENTS

Embodiments of the present invention are explained in detail below with reference to drawings.

First Embodiment

Fig. 1 is a diagram illustrating the construction of the color laser display apparatus as the first embodiment of the present invention. In the construction of Fig. 1, 1 denotes a semiconductor laser device, 2 denotes a modulator, 3 denotes an electrooptic deflector, 4 denotes a wobbling galvanometer, 5 denotes a galvanometer for vertical deflection (sub-scanning), 6 denotes relay lenses, 7 denotes a polygon mirror, and 8 denotes a screen.

The semiconductor laser device 1 is a GaN semiconductor laser device of a tapered-amplifier type having an output of three watts. The semiconductor laser device 1 functions as the aforementioned laser light source, and emits ultraviolet laser light. The intensity of the ultraviolet laser light is modulated by the modulator 2. The electrooptic deflector 3 is provided for correcting irregularity in the raster scan pitch. The galvanometers 4 and 5 are provided for deflecting the ultraviolet laser light in the vertical direction to realize sub-scanning. The relay lenses 6 are provided for condensing and

relaying the ultraviolet laser light. The polygon mirror 7 is provided for deflecting the ultraviolet laser light in the horizontal direction to realize main scanning. Red, green, and blue fluorescent materials are arranged in predetermined positions for each pixel on the screen 8. The red, green, and blue fluorescent materials are ZnCdS:Ag, ZnS:Cu, and ZnS:Ag, respectively.

The composition of the active layer of the semiconductor laser device is adjusted so that the wavelength of the excitation laser light does not exceed 420 nm. Thus, the human eyes are substantially insensible to the excitation laser light. In the case where the active layer of the semiconductor laser device is made of an InGaN material, the wavelength of the excitation laser light does not exceed 420 nm, for example, when the composition of the active layer of the semiconductor laser device is adjusted to be $\text{In}_x\text{Ga}_{1-x}\text{N}$ ($0 < x < 0.2$). In addition, the excitation laser light having a wavelength which does not exceed 420 nm can also be obtained in the case where the active layer of the semiconductor laser device is made of a GaN material.

Thus, the construction of Fig. 1 realizes the aforementioned color laser display apparatus according to the present invention.

Second Embodiment

Fig. 2 is a diagram illustrating the construction of the color laser display apparatus as the second embodiment of the present invention. In the construction of Fig. 1, 11a, 11b, and 11c each denote a semiconductor laser device, 12a, 12b, and 12c each denote a modulator, 13a, 13b, and 13c each denote a dichroic mirror, 14 denotes an electrooptic deflector, 15 denotes a wobbling galvanometer, 16

denotes a galvanometer for vertical deflection (sub-scanning), 17 denotes relay lenses, 18 denotes a polygon mirror, and 19 denotes a screen.

5 The three GaN semiconductor laser devices 11a, 11b, and 11c are provided for emitting three ultraviolet laser light beams corresponding to the three primary colors (red, green, and blue), respectively. Each of the semiconductor laser devices 11a, 11b, and 11c is a semiconductor laser
10 device of a tapered-amplifier type having an output of three watts. The three modulators 12a, 12b, and 12c are provided for modulating intensities of the ultraviolet laser light beams emitted from the three semiconductor laser devices 11a, 11b, and 11c,
15 respectively. The dichroic mirrors 13a, 13b, and 13c are provided for mixing the modulated ultraviolet laser light beams by passing through and/or reflecting the modulated ultraviolet laser light beams. Similar to the first embodiment, the
20 electrooptic deflector 14 is provided for correcting irregularity in the raster scan pitch. The galvanometers 15 and 16 are provided for deflecting the ultraviolet laser light beams in the vertical direction to realize sub-scanning. The relay lenses
25 17 are provided for condensing and relaying the ultraviolet laser light beams. The polygon mirror 18 is provided for deflecting the ultraviolet laser light in the horizontal direction to realize main scanning. Red, green, and blue fluorescent materials
30 are arranged in predetermined positions for each pixel on the screen 19. The red, green, and blue fluorescent materials are ZnCdS:Ag, ZnS:Cu, and ZnS:Ag, respectively.

35 The compositions of the active layers of the semiconductor laser devices are adjusted so that the wavelength of the excitation laser light does not

exceed 420 nm, as explained for the first embodiment.

Thus, the construction of Fig. 2 also realizes the aforementioned color laser display apparatus according to the present invention.

Third Embodiment

Fig. 3 is a diagram illustrating the construction of the color laser display apparatus as the third embodiment of the present invention. In the construction of Fig. 3, reference number 20 denotes a mirror, 21 denotes a Lyot filter, 22 denotes a semiconductor laser device, and 23 denotes a modulator. In Fig. 3, elements having the same reference numbers as Fig. 1 have the same function as the corresponding elements in Fig. 1.

The semiconductor laser device 22 is a semiconductor laser device of a tapered amplifier type having an output of three watts. The semiconductor laser device 22 is provided with the Lyot filter 21 and the mirror 20. A laser light beam emitted from one end of the semiconductor laser device 22 is reflected by the mirror 20, and returns to the semiconductor laser device 22 through the Lyot filter 21, which is provided for reducing the width of the oscillation wavelength distribution of the laser light beam to 0.01 μm before the laser light beam returns to the semiconductor laser device 22. A semiconductor laser device provided with a Lyot filter and a mirror is disclosed in Japanese Unexamined Patent Publication No. 10 (1998)-190105, which is assigned to the present assignee, and the contents of which are incorporated into this specification by reference.

After the laser light beam exits from the other end of the semiconductor laser device 22, the intensity of the ultraviolet laser light is

modulated by the modulator 23. Thereafter, the modulated laser light beam is lead to the screen 8 for scanning the screen 8 in the same manner as the first embodiment.

5 The composition of the active layer of the semiconductor laser device is adjusted so that the wavelength of the excitation laser light does not exceed 420 nm, as explained for the first embodiment.

10 Thus, the construction of Fig. 3 realizes the aforementioned color laser display apparatus according to the present invention.

15 As mentioned above, due to the use of the Lyot filter 21, the width of the oscillation wavelength distribution of the laser light beam is reduced to 0.01 μm , which is one tenth of the conventional width. In addition, since the transmittance of the Lyot filter 21 is 99%, energy conversion efficiency and output power can be increased by the use of the
20 Lyot filter 21, and therefore luminosity of the displayed image can be further increased.

Variations and Other Matters

 The following variations may be made in the first to third embodiments.

25 (1) Instead of the electrooptic deflectors, an inclination correction optical system using a cylindrical lens may be used for correcting irregularity in the raster scan pitch.

30 (2) The modulators may be an acoustooptic modulator (AOM) or an electrooptic modulator (EOM). Instead using modulators, the modulation may be performed directly in the semiconductor laser devices per se.

35 (3) The fluorescent materials arranged on the screens may be inorganic materials or organic materials. As inorganic materials, the

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aforementioned ZnS and ZnCdS materials or Y₂O₂S materials may be used. As organic materials, coumarine 6 may be used.

(4) The laser light sources may be a fiber laser device containing an optical fiber doped with at least one rare earth element including Pr³⁺, and a wavelength conversion element which converts a laser beam generated by the optical fiber into the ultraviolet laser light, where the wavelength of the ultraviolet laser light is 360 nm. Such a fiber laser device is disclosed in Japanese patent application No. 11(1999)-206817, the contents of which are incorporated into this specification by reference.

(5) The laser light source may be an ultraviolet laser device including a semiconductor laser device which has an active layer made of a GaN material so as to emit excitation laser light, and a surface emitting semiconductor laser device which has an active layer made of a GaN material and formed on a substrate. The surface emitting semiconductor laser device is excited by the excitation laser light to emit the ultraviolet laser light, and the wavelength of the ultraviolet laser light is in the range from 380 nm to 420 nm. Such an ultraviolet laser device is disclosed in Japanese patent application No. 11(1999)-257529, the contents of which are incorporated into this specification by reference.

(6) In addition, all of the contents of the Japanese patent applications, Nos. 11(1999)-57187 and 11(1999)-357440 are incorporated into this specification by reference.

Figure 4 shows a color laser display according to a fourth embodiment of the present invention.

This color laser display comprises: a high

output laser light source 42; lenses 43 and 44 that converges the laser light input from laser light source 42 into a line form; an optical modulating array element 46 that modulates said laser light per pixel according to image data 38; optical systems 47 and 48 that form said modulated laser light into an image on a galvano mirror 55; and an optical system 56 that projects the image, deflected by said galvano mirror 55, onto a screen 57.

As shown in Figure 4, the laser light source 42, which is the fundamental light source, consists of a laser portion 49 that includes semiconductor lasers, and multimode fibers 41 that are optically coupled with each of said semiconductor lasers. In order to emit the laser light linearly extending in a lengthwise direction of the optical modulating array element 46, which is formed in an elongated manner, a plurality (for example, 100-however, only 5 are shown in the figure) of said multimode fibers are arranged along the lengthwise direction of said optical modulating array element 46. The detailed construction of the laser light source 42 will be described later.

Laser light source 42, lenses 43 and 44, optical modulating array element 46, as well as image forming optical systems 47 and 48 are fixed to a casing 58 by a fixing member (not shown). The lens 48 is supported by a guide (not shown) to be movable along the optical axis. Each of the laser light source 42 and the optical modulating array element 46 are connected to a controller (not shown) via a driver (not shown) that controls them.

As the laser light source 42, a laser light source comprising a gallium nitride semiconductor laser coupled to a fiber as disclosed in Japanese Patent Application 2001-273870 may be employed, for

example. This laser, as shown in Figure 5, is constituted by, for example, eight multimode gallium nitride (GaN) semiconductor lasers LD1, LD2, LD3, LD4, LD5, LD6, LD7, as well as LD8, and a wave
5 multiplexing optical system 234. The emission wavelengths of the GaN semiconductor lasers LD1-LD8 are wavelengths capable of being emitted at high output selected from within a range of capable emission, which is 390-410nm. For example, the
10 wavelengths may be set at 395nm, 396nm, 397nm, 398nm, 399nm, 400nm, 401nm, and 402nm respectively, differing by one nm each. At this time, every laser's output is set at a common value of 100 mW.

Collimating lenses C1-C8, corresponding to
15 each of the GaN semiconductor lasers L1-L8, are provided to collimate the diffuse laser beams B1-B8 emitted therefrom.

The wave multiplexing optical system 234 consists of a plane parallel prism 236, narrow
20 bandwidth band pass filters F3, F5, and F7 adhesively attached to one surface 236a thereof, and narrow bandwidth band pass filters F2, F4, F6, and F8 adhesively attached to an opposite surface 236b thereof. Each of these narrow bandwidth band pass
25 filters F2-F8 are formed to reflect light incident on the adhesive surfaces thereof, adhered to the surfaces 236a and 236b of plane parallel prism 236 at a reflectance rate of, for example, 98%. Light of a predetermined wavelength range that is incident
30 on a surface opposite to the adhesive surface is to be transmitted at a transmittance rate of, for example, 90%. The transmittance spectra of these narrow bandwidth band pass filters F2-F8 are shown in Figure 7, along with the transmittance spectrum
35 of a narrow bandwidth band pass filter F1, to be described later.

Each of the GaN semiconductor lasers LD1-LD8 are arranged so that each of the laser beams B1-B8 respectively emitted therefrom are incident on the narrow bandwidth band pass filters F2-F8 at an angle of incidence of 5°. The laser beams B1-B8 emitted from each of the GaN semiconductor lasers LD1-LD8 at wavelengths of 395nm, 396nm, 397nm, 398nm, 399nm, 400nm, 401nm, and 402nm, respectively, after entering the plane parallel prism 236, are multiplexed into a single beam while being reflected by the narrow bandwidth band pass filters F2-F8. This multiple wavelength high output (for example, approximately 0.5W) laser beam B is emitted from the plane parallel prism 236, focused by a lens 233, and enters the multimode fiber 41, having a core diameter of approximately 10µm and an NA of 0.3. By arranging the output faces of the multimode fibers 41 in an array as shown in Figure 6, for example, each of the multimode fibers 41 is positioned in respective one of grooves, which are formed in a fiber holder 45 in the manner such that they extend parallel to the direction in which the beam is emitted and a 50W linear beam may be obtained by arraying 100 of these multimode fibers 41. Note that, as shown in Figure 4, the laser portion 49, which includes the GaN semiconductor lasers LD1-LD8, the plane parallel prism 236 as well as the lens 233 is provided externally to a casing 58 of an exposure head 14.

Next, with reference to Figure 8 and Figure 9, the construction and operational principle of a GLV (Grating Light Valve) element that is to be employed as the optical modulating array element 46. The GLV element 201 is an SLM (Spatial Light Modulator) of a MEMS (Micro Electro Mechanical Systems) type, as disclosed in U.S. Patent 5,311,360, for example. As

shown in Figure 6, the GLV element 201 is constituted of a plurality of unidirectionally arranged gratings.

As shown in Figure 8, a plurality (for example, 6,480) of ribbon-form micro bridges 209 that act as movable gratings is provided on a substrate 203, formed of silicon or the like, of the GLV element 201. A plurality of slits 211 is formed by the parallel arrangement of the micro bridges 209. The micro bridges 209 are maintained at a predetermined distance from the substrate 203.

As shown in Figure 9, the bottom surface of the micro bridge 209, that is, the surface that faces the substrate 203, is constituted of a flexible beam 209a of SiNx or the like. The top surface is constituted of a reflective electrode film 209b of a single layer metallic film of aluminum (or gold, silver, copper and the like). By forming the reflective electrode layer with gold, silver, copper or the like, reflectivity can be improved according to the wavelength of light utilized. The substrate 203, the micro bridges 209 and a controller (not shown) constitute the movable grating drive means.

The driving of the GLV element 201 is controlled by the on/off state of a voltage applied between the micro bridges 209 and the substrate 203. If the voltage applied between the micro bridge 209 and the substrate 203 is turned on, static electric attraction is generated therebetween by an inducted static electric charge, and the micro bridge 209 bend towards the substrate 203. When the applied voltage is turned off, the bend is released, and the micro bridge 209 elastically returns to the predetermined distance away from the substrate at which it is maintained. Generally, one pixel is

constituted by a plurality (for example, six) micro
 bridges 209, and by alternately positioning a micro
 bridge 209 to have a voltage applied thereto, the
 applied voltage creates a diffraction grating,
 5 thereby performing optical modulation.

In the case that a voltage is not applied to
 the micro bridges 209, all of the reflective
 surfaces thereof are matched in height, and no
 optical path difference arises in a light reflected
 10 thereby. On the other hand, if a voltage is applied
 to every other micro bridge 209, by the principle
 described above, the central portions of said micro
 bridges bend, and a reflective surface becomes
 alternately stepped. If a laser light is incident
 15 on this reflective surface, an optical path
 difference arises in the light reflected by the
 unbent micro bridges 209, and a diffraction
 phenomenon of the light occurs. The intensity of
 the primary diffracted light I_{1st} depends on the
 20 optical path difference, and may be expressed by the
 equation below. In this case, the intensity of the
 diffracted light is maximal when the optical path
 difference is $\lambda/2$.

Equation 1:

25
$$I_{1st} = I_{max} \sin (2\pi d/\lambda)$$

Next, the operation of the color display of
 the present embodiment will be described. In order
 to display an image on screen 57, a laser light is
 two dimensionally scanned on the screen 57
 30 comprising a plurality of pixels, each having
 R(red), G(green), and B(blue) fluorescent materials.
 Image data 38 is input into the controller (not
 shown) of the optical modulating array element 46,
 and is recorded in a frame memory in said
 35 controller. This image data represents the density
 of each of the pixels that constitute the image.

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The linear beam emitted from laser light source 42 and extending in a lengthwise direction of the optical modulating array element 46 is irradiated linearly onto said elongated optical modulation array element 46, and is simultaneously modulated thereby. Thereafter, the aforementioned linear light is caused to scan an area two dimensionally by a deflection device such as the galvano mirror 55. Then, the image is projected onto the screen 57 by a projection optical system 56. In this manner, the laser light two dimensionally scans and projects the fluorescent materials on the screen, thereby showing an image on the screen.

Next, a color laser display according to a fifth embodiment will be described. This color laser display is of a similar construction to that of the fourth embodiment except that the laser light source 42 of the fourth embodiment has been replaced with a different laser light source to be described below. As this laser light source, one could be employed as disclosed in Japanese Patent Application 2001-273870 and Japanese Patent Application 2001-273871. This laser light source 42, as shown in Figure 12, comprises: a plurality of wave multiplexing modules that multiplex beams emitted from a plurality of semiconductor laser chips into one fiber; and a plurality of optical fibers 41 that are optically coupled to each of said modules 520 and arranged in an array to emit a linear laser luminous flux. That is, the output face portions of the plurality of optical fibers 41 are bundled in an array form.

Each of the wave multiplexing modules 520 are constructed of a plurality (for example, seven) of side multimode gallium nitride semiconductor lasers 530 fixedly arranged on a heat sink block 510 (made

of copper, for example); a plurality of collimating lenses 540 facing each of the semiconductor lasers 530; and a focusing lens 550, and are optically coupled to a single multimode optical fiber 41, as shown in Figure 10, Figure 11a and Figure 11b.

The heat sink block 510, the semiconductor lasers 530, the collimating lenses 540, as well as the focusing lens 550 are all housed in a box like package 580 having an open top. By the open top of package 580 being closed by a package lid 581, the aforementioned elements are held in the hermetically sealed space created by the package 580 and the package lid 581.

A base board 590 is fixed to the bottom surface of the package 580, the aforementioned heat sink block 510 is attached to the upper surface of the base board 590, and a collimating lens holder 541 that holds the collimating lenses 540 is fixed on the heat sink block 510. In addition, a focusing lens holder 551 that holds the focusing lens 550 and a fiber holder 552 that holds the input end portion of the multimode optical fiber 41 are fixed on the upper surface of the base board 590. Also, the wiring 555 that supplies a driving current to the gallium nitride semiconductor lasers 530 communicate with the outside of the package 580 through an aperture (not shown) in the side wall of the package 580, sealed with an airtight sealing material.

The collimating lenses 540 are formed so that the aperture diameter in a direction parallel to the row of emission points of the gallium nitride semiconductor lasers 530 is smaller than the aperture diameter in a direction perpendicular to said direction (that is, in a thin, long shape), and are closely arranged in the direction parallel to the aforementioned row of emission points. As

the gallium nitride semiconductor lasers 530, those that possess an emission width of $2\mu\text{m}$, and spreading angles in a direction parallel to the active layer and perpendicular to the active layer of 10° and 30° respectively, may be employed. These gallium nitride semiconductor lasers 530 are provided so that their emission points line up in a single line in a direction parallel to the active layers thereof.

Accordingly, the laser beams emitted from each of the emission points are incident on each of the elongate collimating lenses 540 as described above in a state wherein the direction with the maximum spreading angle matches the direction of the greater aperture diameter, and the direction with the minimum spreading angle matches the direction of the lesser aperture diameter. That is, each of the elongate collimating lenses 540 are utilized with an extremely decreased ineffective portion corresponding to the oval sectional shape of the laser beam incident thereto.

For example, in the present embodiment, a collimating lens 540 having aperture diameters in the horizontal and vertical directions of 1.1mm and 4.6mm respectively, a focal distance of 3mm , an NA of 0.6 , and a laser beam to be incident thereto having a beam diameter in the horizontal and vertical directions of 0.9mm and 2.6mm respectively, may be utilized. In addition, the collimating lenses 540 are positioned with a pitch of 1.25mm .

The focusing lens 550 is an elongate cutout of an area containing the optical axis of an aspherical lens, in a shape that is long in a direction of the row of the collimating lenses 540, that is, a horizontal direction, and short in a

direction perpendicular thereto. As the focusing lens 550, that which has a focal distance of 12.5mm and an NA of 0.3 may be employed. This focusing lens 550 is formed by, for example, molding resin or optical glass.

On the other hand, as the multimode optical fiber 41, one that is based on the graded index model manufactured by Mitsubishi Densen, wherein the center portion of the core is of a graded index form and the peripheral portion is of a step index form with a core diameter of 25 μ m, an NA of 0.3, and a transmittance rate of 99.5% of the terminal face coating may be utilized. That is, the value of the core diameter X NA becomes 7.5 μ m.

In the case that the coupling efficiency between the laser beams and the multimode optical fiber 41 is 0.9, the output of each of the gallium nitride semiconductor lasers 530 is 100mW, and the number of the gallium nitride semiconductor lasers 530 is 7, a multiplexed laser beam with an output of 630mW (100mW X 0.9 X 7) will be obtained.

With regard to the gallium nitride semiconductor lasers 530, their emission wavelength is 405 \pm 10nm, and their maximum output is 100mW. The laser beams emitted from these gallium nitride semiconductor lasers 530 in a diffuse state are collimated by the collimating lenses 540, corresponding thereto. The collimated laser beams are focused by the focusing lens 550, and converge upon the input terminal face of the core of the multimode optical fiber 41.

The collimating lenses 540 and the focusing lens 550 constitute the focusing optical system, and that, in combination with the multimode fiber 41, constitute the wave multiplexing optical system. That is, the laser beams focused by the

5 focusing lens 550 as described above enter the core
of multimode optical fiber 41, propagate
therethrough, are multiplexed into a single laser
beam, and is emitted therefrom. In the case that
an optical fiber of a step index form or one that
possesses a high NA value is employed as the
multimode optical fiber 41, those of a graded index
form as well as combinations therewith are
applicable.

10 Note that instead of separate collimating
lenses 540 corresponding to each of the
semiconductor lasers 530, a collimating lens array
that has a number of lens elements that correspond
to each of the semiconductor lasers 530 may be
15 employed. In the case that separate collimating
lenses 540 are employed, by arranging them close to
each other and by decreasing the positioning pitch
of the gallium nitride semiconductor lasers, space
utilization efficiency can be improved. However,
20 by utilizing a collimating lens array, said effect
can be further heightened. In addition, if space
utilization efficiency is improved in this manner,
the number of laser beams to be multiplexed can be
increased, and the requirement for positioning
25 accuracy of the gallium nitride semiconductor laser
530, the focusing optical system as well as the
multimode optical fiber 41 during assembly can be
comparatively eased.

30 The focal distance and the numerical aperture
of each of the lens elements of the collimating
lens array, or of each separate collimating lens
540 is set to f_1 and NA_1 , respectively. The focal
distance of the focusing lens 550 is set to be f_2 ,
the numerical aperture of the multimode optical
35 fiber 41 is set to NA_2 , and the space utilization
efficiency rate is set to η . Note that this space

utilization efficiency rate η is defined by the space occupied by the optical path of the laser beams in proportion to the space utilized by the laser beams, and η is equal to one in a state in which the laser beams are directly adjacent to each other.

Under the conditions described above, the magnification α of a lens diameter, that is, the ratio between the diameter of a beam spot at each emission point of the gallium nitride semiconductor lasers and the diameter of a beam spot at the terminal face of the core of the multimode fiber 41, can be given by equation (1) below. Note that N is the number of laser beams to be multiplexed.

Equation 2:

$$a = \frac{f_2}{f_1} = \frac{NA_1}{\left(\frac{NA_2}{N} \times \eta\right)} = \frac{NA_1}{NA_2} \times \frac{N}{\eta}$$

As is clear from equation (1), the magnification α decreases as the space utilization efficiency rate η increases. As the magnification α decreases, the distance that the laser beam moves on the terminal face of the core of the multimode optical fiber 41 decreases in the case that there is a shift in the relative position between the gallium nitride semiconductor laser and the focusing optical system as well as the multimode optical fiber. Therefore, it becomes possible to make the laser beam incident on the core of the multimode optical fiber 41 correctly even if the positioning accuracy during assembly is relatively eased. In addition, as the value of η is brought closer to one, α may be decreased, and the number of laser beams to be multiplexed N may be increased for that amount. Therefore, high output is

possible with a large allowance for positional shift, even if the number of lasers to be multiplexed N is increased.

5 In order to emit the laser light linearly extending in a lengthwise direction of the elongate optical modulating array element 46, the fibers 41, provided for each of the plurality of wave multiplexing modules 520 are arranged along the lengthwise direction of said optical modulating
10 array element 46 in the form of an array.

As has been described above, the laser light emitted from each of the gallium nitride semiconductor lasers 530 enter the optical fiber 41 after being collimated by the collimating lens 540
15 that corresponds to each of said lasers 530. In the case that seven gallium nitride semiconductor lasers are provided in the wave multiplexing module 520, seven collimated laser beams are optically coupled to the fiber 41 by the aspheric lens 550.
20 If 100 of these fibers, having a core diameter of 25 μ m, an NA of 0.3, and an output of 0.5W, are provided, a 50W (0.5 X 100) linear super high output beam will be emitted from the linearly provided fibers. The linear beam is collimated in
25 a direction indicated by the arrow Y while being converged in a direction perpendicular thereto, and enters the elongate optical modulation array.

Instead of the 50W (0.5 X 100) linear high output beam provided by the arrayed fibers as
30 described above, an array type semiconductor laser, in which a plurality of semiconductor laser chips 560 as shown in Figure 13A, arranged along a predetermined direction as shown in Figure 13B as disclosed in Japanese Patent Application 2001-
35 273849 may be utilized. The light source 42 is constituted by a plurality of semiconductor laser

chips. Each of the laser chips 560 possesses a plurality of emission points 570. If the output of each emission point 570 is 0.1W, and the number of emission points is five, the output of each of the laser chips 560 is 0.5W (0.1W X 5). If the light source 42 is constituted by 34 semiconductor laser chips 560, it will be able to emit a 17W (0.5W X 34) high output array beam. By arranging three of these 17W array beams, a 50W class linear high output beam can be obtained, similar to that provided by the arranged fibers described above.

The high output beam obtained by the above means is projected onto the screen after being deflected, and shows an image on said screen as in the fourth embodiment.

In the fourth and fifth embodiments described above, examples in which high output laser light sources, which utilized gallium nitride semiconductor lasers multiplexed and coupled to fibers were employed have been described. However, the high output laser light source may be of one of the six constructions described below.

- 1) A gallium nitride semiconductor laser. Preferably, an array type semiconductor laser comprising a plurality of gallium nitride semiconductor lasers as shown in Figure 10 and Figure 11.
- 2) A semiconductor laser excited solid state laser as shown in Figure 15, in which a laser beam, obtained by exciting a solid state laser crystal with a gallium nitride semiconductor laser, is wavelength converted by an optical wavelength conversion element then emitted.
- 3) A fiber laser as shown in Figure 17, in which a laser beam, obtained by exciting a

fiber with a gallium nitride semiconductor laser, is wavelength converted by an optical wavelength conversion element then emitted.

- 5 4) A fiber laser or a fiber amplifier as shown in Figure 16, in which a laser beam, obtained by exciting a fiber with a semiconductor laser that emits light in an infrared range, is wavelength converted by an optical wavelength conversion element then emitted.
- 10
- 5) A linear laser light source or a planar laser light source, in which fibers, each of which are coupled to a gallium nitride semiconductor laser or a plurality of gallium nitride semiconductor lasers via a wave multiplexing optical system, are arranged in an array as shown in Figure 12, or bundled.
- 15
- 6) A laser light source comprising any one of the above five laser light sources and a wave multiplexing optical system.
- 20

Figure 14 shows an example of a layering structure of a gallium nitride semiconductor laser having a broad area emission range, listed as 1) above. In the gallium nitride semiconductor laser having this layering structure, an n-type $\text{Ga}_{1-z_1}\text{Al}_{z_1}\text{N}/\text{GaN}$ super lattice cladding layer 102 ($0.05 < z_1 < 1$), an n-type or i-type GaN photoconductive layer 104, an $\text{In}_{1-z_2}\text{Ga}_{z_2}\text{N}$ (doped with Si)/ $\text{In}_{1-z_3}\text{Ga}_{z_3}\text{N}$ multiple quantum well active layer 106 ($0.01 < z_2 < 0.05$, $0.1 < z_3 < 0.3$), a p-type $\text{Ga}_{0.8}\text{Al}_{0.2}\text{N}$ carrier blocking layer 108, an n-type or i-type GaN photoconductive layer 110, a p-type $\text{Ga}_{1-z_1}\text{Al}_{z_1}\text{N}/\text{GaN}$ super lattice cladding layer 112, and a p-type GaN contact layer are sequentially layered on an n-type

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GaN (0001) substrate 100. An insulating film 116 is formed on the p-type GaN contact layer excepting a stripe region with a width of approximately 50 μ m. A p-side electrode 118 is formed on said stripe region. An n-side electrode is formed on the reverse surface of the substrate 100. Note that the oscillation wavelength band of this semiconductor laser is 440nm, and the width of its emission range is 50 μ m. Therefore, the output obtainable therefrom is on the order of 2W, and its light conversion rate is approximately 15%. Laser light emitted from twenty five of these semiconductor lasers is input into a fiber with a core diameter of 500 μ m to obtain a fiber excitation module 122 having an output of 50W.

Figure 15 shows an example of a semiconductor laser excited solid state laser listed as 2) above, in which a laser beam, obtained by exciting a solid state laser crystal with a gallium nitride semiconductor laser, is wavelength converted by an optical wavelength conversion element then emitted. This semiconductor laser excited solid state laser comprises: an excitation module 122 that emits a laser beam 121 as the excitation light; a fiber F that has its input terminal face optically coupled to said excitation module 122; a focusing lens 124 that focuses aforementioned laser beam 121, which is emitted as a diffuse light from the fiber F; a LiYF₄ crystal 126 doped with Pr³⁺ (hereinafter referred to as Pr:YLF crystal) which is a solid state laser medium; a resonating mirror 128 positioned on a light emission side of said Pr:YLF crystal 126; an optical wavelength conversion element 130 positioned between said Pr:YLF crystal 126 and said resonating mirror 128; and an etalon 132.

The optical wavelength conversion element 130 consists of a LiNbO₃ crystal doped with MgO, which is a nonlinear optical material, provided with a frequency domain inversion structure. The frequency of the frequency domain inversion structure, for example, in the case that the fundamental wavelength is 720nm and the wavelength of the second harmonic is 360nm, is set to 1.65μm to be a primary frequency relative to these wavelengths. Further, the etalon 132, which acts as the wavelength selection element, realizes noise reduction by oscillating the solid state laser in a single vertical mode.

As the semiconductor laser 122, one may be employed of a broad area type that possesses an InGaN active layer and oscillates at a wavelength of 450nm, for example. The terminal surface 126a on the light incident side of the Pr:YLF crystal 126 transmits light having a wavelength of 450nm favorably with an 80% transmittance rate while it is highly reflective for a wavelength of 720nm, which is one of the oscillation lines of Pr³⁺. The light incident side of the Pr:YLF crystal is provided with a low reflective coating with regard to the oscillation lines of Pr³⁺ other than 720nm, i.e., 400nm, 650nm, 800nm and longer. The terminal surface 126b on the light emission side of the Pr:YLF crystal 126 is provided with a coating that has low reflectivity with regard to light having a wavelength of 720nm and high reflectivity with regard to a second harmonic of said light that has a wavelength of 360nm. Meanwhile, on the mirror surface 128a of the resonating mirror 128 is provided with a coating that has high reflectivity with regard to light having a wavelength of 720nm, transmits over 95% of light having a wavelength of

360nm, and has low reflectivity with regard to light having wavelengths of 490nm, 650nm, 800nm and longer.

In this semiconductor laser excited solid state laser, a laser beam 121 having a wavelength of 450nm is emitted from the semiconductor laser 122 and enters the Pr:YLF crystal 126 by being transmitted through the aforementioned terminal surface 126b. The Pr:YLF crystal emits a light having a wavelength of 720nm due to the excitation of Pr³⁺ by the laser beam 121. At this time, the level may be considered to be 3P₀ 3F₄. Then, laser oscillation is caused to occur by the resonator, which comprises the terminal surface 126b of the Pr:YLF crystal and the mirror surface 128a of the resonating mirror, thereby generating a solid state laser beam 123 having a wavelength of 720 nm. This laser beam 123 enters optical wavelength conversion element 130 and is converted to a light of half its original wavelength, that is, a second harmonic 125 having a wavelength of 360nm. As the mirror surface 128a of the resonating mirror is provided with the coating as has been described above, only second harmonic 125 having a wavelength of 360nm is emitted from the resonating mirror 128.

Figure 16 shows an example of fiber laser listed as 4) above, in which a laser beam, obtained by exciting a fiber with a semiconductor laser that emits light in an infrared range, is wavelength converted by an optical wavelength conversion element then emitted. This fiber laser is a FHG (Fourth Harmonic Generation) fiber laser, and comprises: a pulse DFB (Distributed Feed Back) semiconductor laser 134 that emits a laser beam 133 having a wavelength of 1560nm; a collimating lens 136 that collimates the aforementioned laser beam

133, which is a diffuse light; a focusing lens 138 that focuses the collimated laser beam 133; a half mirror 142 positioned between said collimating lens 136 and said focusing lens 138; a fiber 140 having
5 a core which has been doped with both Er³⁺ and Yb³⁺; a focusing lens 154 that focuses the laser beam 133 emitted from said fiber 140; and a wavelength conversion portion 156 that obtains a wavelength converted light from the focused laser
10 beam 133 incident thereto.

The wavelength conversion portion 156 consists of a SHG (Second Harmonic Generation) element 158 that converts the laser beam 133 incident thereto into a laser beam having half the original wavelength thereof (780nm) and a FHG (Fourth Harmonic Generation) element 160 that converts the laser beam 133 incident thereto into a laser beam having a quarter of the original wavelength thereof (390nm). Both the SHG element 158 and the FHG element 160 are bulk type wavelength conversion crystals consisting of a LiNbO3 doped with MgO, which is a nonlinear optical material, provided with a frequency domain inversion structure.

25 A semiconductor laser 144 that emits a laser
beam 135 having a wavelength of 940nm is positioned
on the side of the half mirror 142 to which the
light is incident (in the figure, the lower side of
the half mirror 142). A collimating lens 146 is
30 positioned between the semiconductor laser 144 and
the half mirror 142.

As shown in Figure 16, at the fiber 140, the laser beam 133 is amplified by receiving energy from fluorescent materials of the same wavelength (1560nm), and is emitted from the emission terminal surface 140b of said fiber 140. The laser beam

133, having a wavelength of 1560nm, is focused by the focusing lens 154 and enters the wavelength conversion portion 156. The laser beam 133 is converted into a fourth harmonic thereof at the wavelength conversion portion, and is emitted therefrom as a laser beam 137 having a wavelength of 390nm. Note that that an output of 5W can be obtained by this fiber laser.

Note that this fiber laser may also be constructed as a THG (Third Harmonic Generation) fiber laser by constructing the wavelength conversion portion with a SHG (Second Harmonic Generation) element that converts a laser beam incident thereto into a laser beam having half the original wavelength thereof, and a THG (Third Harmonic Generation) element that converts a laser beam incident thereto into a laser beam having a third of the original wavelength thereof.

Figure 17 shows a fiber laser listed as 3) above, in which a laser beam, obtained by exciting a fiber with a gallium nitride semiconductor laser, is wavelength converted by an optical wavelength conversion element then emitted. This fiber laser is a SHG (Second Harmonic Generation) laser, and comprises: a fiber input excitation module 174 that employs a gallium nitride semiconductor laser to emit a laser beam 173 having a wavelength of 450nm; a collimating lens 176 that collimates said laser beam 173, which is a diffuse light; a focusing lens 178 that focuses said collimated laser beam 173; a fiber 180 that has a core doped with Pr³⁺; a focusing lens 194 that focuses the laser beam 182 having a wavelength of 720nm emitted from said fiber 180; and a SHG (Second Harmonic Generation) element 196 that converts laser beam 182, which has been focused by focusing lens 194 into a laser beam

177 having half the wavelength thereof (360nm).
The SHG element 196 is a bulk type wavelength
conversion crystal consisting of a LiNbO3 doped
with MgO, which is a nonlinear optical material,
5 provided with a frequency domain inversion
structure. A coating is provided on the terminal
faces 180a and 180b of the fiber 180 that has an AR
(Anti Reflective) property with regard to light of
the aforementioned wavelengths.

10 In this fiber laser, the laser beam 173
having a wavelength of 450nm emitted from the fiber
input excitation module 174 that employs a gallium
nitride semiconductor laser is focused by the
focusing lens 178 and enters the fiber 180.
15 Fluorescence of a wavelength of 720nm is generated
by the laser beam 173 within said fiber 180, is
resonated between the two terminal surfaces 180a
and 180b thereof, and a laser beam 182 having a
wavelength of 720nm is emitted from emission
20 terminal surface 180b. The laser beam 182 having a
wavelength of 720nm emitted from the fiber 180 is
focused by the focusing lens 194 and is input to
the SHG element 196. The laser beam 182 is
converted into a second harmonic thereof by the SHG
25 element, and is emitted therefrom as a laser beam
177 having a wavelength of 360nm.

In the fourth and fifth embodiments described
above, examples in which an optical modulation
array element consisting of an array of GLV
30 (Grating Light Valve) elements, which are one type
of SLM (Spatial Light Modulator) of a MEMS (Micro
Electro Mechanical Systems) type have been
described. However, the light beam may be
modulated by other modulating means. Note that the
35 term MEMS refers collectively to all micro systems
including micro sized sensors, actuators, and

control circuits manufactured by micromachining technology with IC (Integrated Circuit) manufacturing processes as a base. In this case, the MEMS type SLM refers to a spatial light
5 modulator driven by an electromechanical operation that utilizes static electricity.

For example, in the case that the laser light source is to be continuously driven with a low light output, spatial light modulators other than
10 those of an MEMS type, such as a PLZT (Plomb Lanthanum Zirconate Titanate) element, which is an optical element that modulates the transmitted light through an electro optical effect, or a liquid crystal shutter may be employed. Or, in the
15 case that the laser light source is to be pulse driven or driven at a high output, spatial light modulators such as a DMD (Digital Mirror Device), a total reflection type spatial light modulator, an interference type spatial light modulator, a
20 reflection type spatial light modulator, or another MEMS type spatial light modulator may be employed.

Further, in the case that a two dimensional spatial light modulator such as a DMD is employed, the light beams from the light sources listed above
25 (1-6) are irradiated on said spatial light modulator two dimensionally. Particularly in the case that a laser light source in which fibers, each of which are coupled to a gallium nitride semiconductor laser or a plurality of gallium
30 nitride semiconductor lasers via a wave multiplexing optical system as listed as 5) above is utilized, it is preferable that said fibers shown in Figure 12 are bundled to provide a planar laser light source. The light modulated by a two
35 dimensional spatial light modulator such as a DMD is irradiated onto a projection optical system that

corresponds to the projection optical system 56 shown in Figure 4, projected onto the screen, and shows an image thereon by simultaneously exciting the desired fluorescent materials thereon. In the case that a two dimensional spatial light modulator such as a DMD is employed, the necessity to scan the light from the optical modulation element as in the fourth embodiment is obviated.

In the fourth and fifth embodiments, a single laser light source 42 excited the R (Red), G (Green) and B (Blue) fluorescent materials. However, laser light sources 42 dedicated to each of said R, G, and B fluorescent materials may be employed, similar to the second embodiment illustrated in Figure 2. In this case, the laser light emitted from each of the plurality of laser light sources 42 is mixed by being either reflected or transmitted by a dichroic mirror as illustrated in Figure 2. This mixed laser light may be employed as the laser light of the fourth or fifth embodiments, and each of the R, G, and B fluorescent materials may be excited by a laser light source 42 dedicated thereto.